Application Number:	107	10789799					
Filing Date:	27-	27-Feb-2004					
Title of Invention:	EN	ENCAPSULATION METHOD FOR LEADLESS SEMICONDUCTOR PACKAGES					
First Named Inventor/Applicant Name:	Fra	Frank Kuo					
Filer:	An	Anthony C. Murabito/Mina Oliveri					
Attorney Docket Number:	VIS	VISH-4123.DIV					
Filed as Large Entity							
Utility under 35 USC 111(a) Filing Fees							
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)		
Basic Filing:							
Pages:							
Claims:							
Miscellaneous-Filing:							
Petition:							
Patent-Appeals-and-Interference:							
Post-Allowance-and-Post-Issuance:							

Publ. Fee- early, voluntary, or normal

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension-of-Time:				
Miscellaneous:				
Printed copy of patent - no color	8001	10	3	30
	Tot	1840		